BORN SEMICONDUCTOR

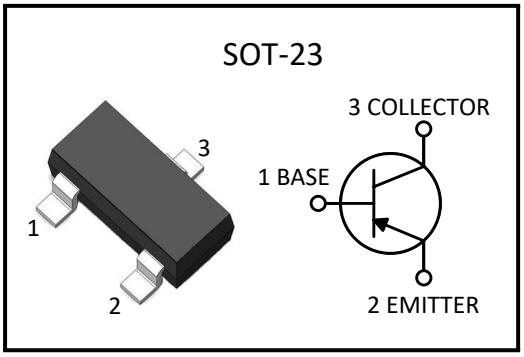
MMBT2907A

PNP Plastic-Encapsulate Transistor

Features

- V_{CE}=-60V
- I_C=-0.6A
- f_T=200MHZ @V_{CE}=-20V, I_C=-50mA,f=100MHz

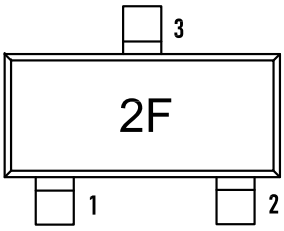
Package



Description

- Complementary NPN Type available MMBT2222A
- Epitaxial planar die constructio
- SOT-23 Plastic Package.

Marking



Ordering information

Order code	Package	Marking	Base qty	Delivery mode
MMBT2907A	SOT-23	2F	3K	Tape and reel

Absolute Maximum Ratings @T_A=25°C unless otherwise noted

Symbol	Parameter	Value	Unit
V_{CBO}	Collector-Base Voltage	-60	V
V_{CEO}	Collector-Emitter Voltage	-60	V
V_{EBO}	Emitter-Base Voltage	-5	V
I_C	Collector Current	-0.6	A
P_C	Collector Power Dissipation	250	mW
$R_{\theta JA}$	Thermal Resistance From Junction To Ambient	500	°C/W
T_J	Junction Temperature	150	°C
T_{stg}	Storage Temperature	-55 to + 150	°C

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Revision: 2022-Jan-1-A

MMBT2907A

PNP Plastic-Encapsulate Transistor

Electrical Characteristics (T_A=+25°C, unless otherwise specified)

Symbol	Parameter	Test condition	Min.	Typ.	Max.	Unit
$V_{(BR)CBO}$	Collector-base breakdown voltage	I_C=-10μA, I_E=0	-60	–	–	V
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	I_C=-10mA,I_B=0	-60	–	–	
$V_{(BR)EBO}$	Emitter-base breakdown voltage	I_E=-10μA,I_C=0	-5	–	–	
I_{CBO}	Collector cut-off current	V_{CB}=-50V,I_E=0	–	–	-0.02	uA
I_{EBO}	Emitter cut-off current	V_{CE}=-3V,I_C=0	–	–	-0.01	
I_{CEX}	Collector cut-off current	V_{CE}=-30V,V_{EB}=-0.5V	–	–	-0.05	
$h_{FE(1)}$	DC current gain	V_{CE}=-10V,I_C=-150mA	100	–	300	
$h_{FE(2)}$		V_{CE}=-10V,I_C=-0.1mA	75	–	–	
$h_{FE(3)}$		V_{CE}=-10V,I_C=-1mA	100	–	–	
$h_{FE(4)}$		V_{CE}=-10V,I_C=-10mA	100	–	–	
$h_{FE(5)}$		V_{CE}=-10V,I_C=-500mA	50	–	–	
$V_{CE(sat)}$	Collector-emitter saturation voltage	I_C=-150mA,I_B= -15mA	–	–	-0.4	V
		I_C=-500mA,I_B=-50mA	–	–	-1.6	
$V_{BE(sat)}$	Base-emitter saturation voltage	I_C=-150mA,I_B=-15mA	–	–	-1.3	
		I_C=-500mA,I_B=-50mA	–	–	-2.6	
f_T	Transition frequency	V_{CE}=-20V,I_C=-50mA,f=100MHZ	200	–	–	MHZ
t_d	Delay time	V_{CE}=-30V, I_C=-150mA,I_{B1}=-15mA	–	–	10	nS
t_r	Rise time		–	–	25	
t_s	Storage time	V_{CE}=-6V,I_C=-150mA, I_{B1}=-I_{B2}=-15mA	–	–	225	
t_f	Fall time		–	–	60	

Note: Pulse test: tp≤300μS, δ≤0.02.

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MMBT2907A

PNP Plastic-Encapsulate Transistor

Typical Performance Characteristics(T_J = 25 °C, unless otherwise noted)

Figure 1 : I_C—— V_{CE}

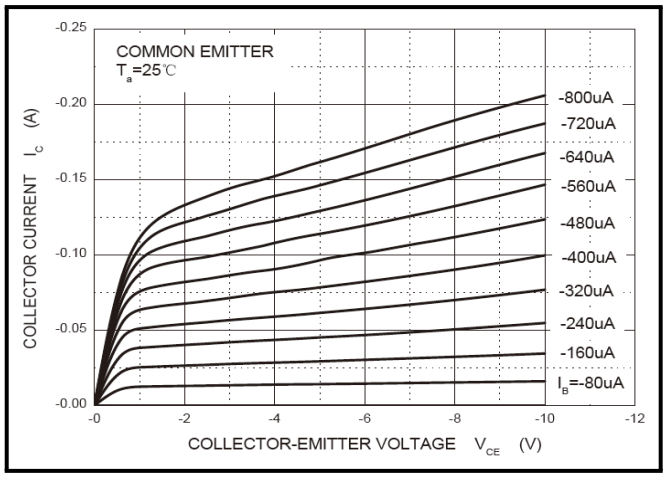


Figure 2 :h_{FE}——I_C

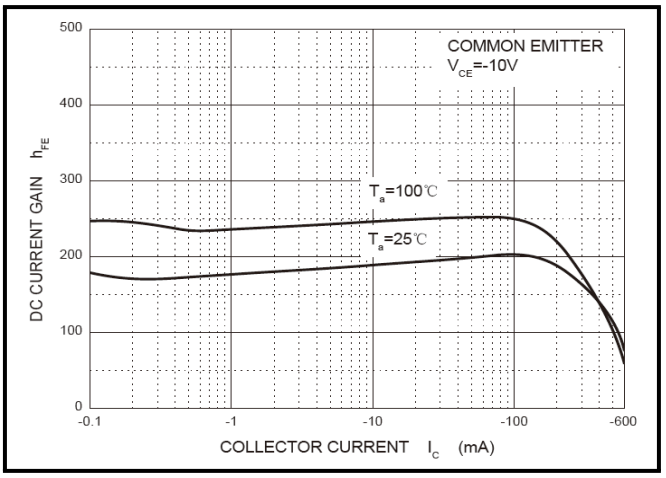


Figure 3 : $V_{BE(sat)}$——I_C

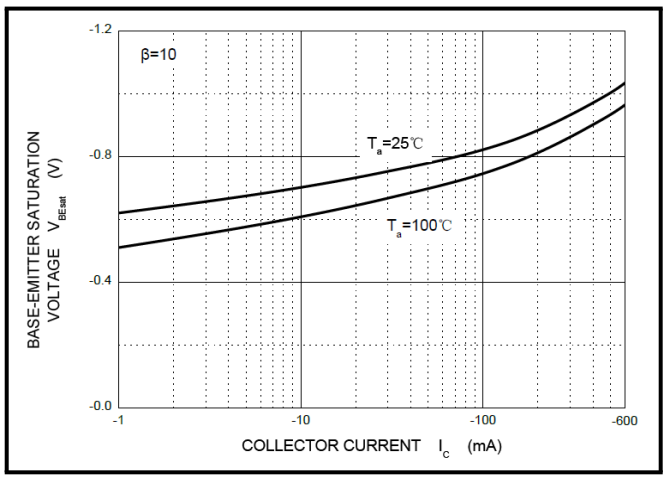


Figure 4 : $V_{CE(sat)}$—— I_C

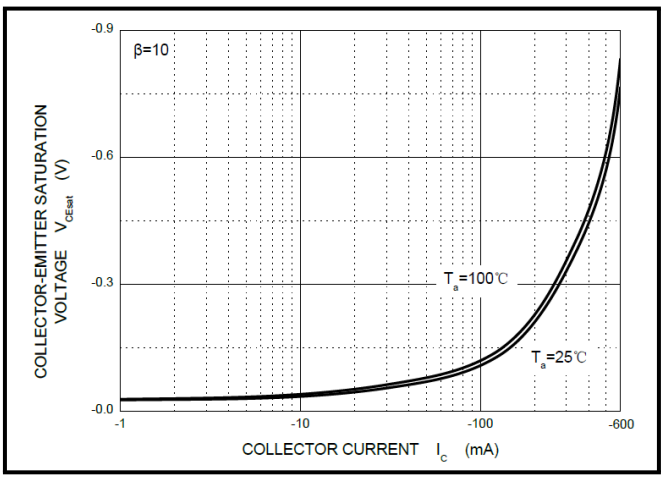


Figure 5 : I_C——V_{BE}

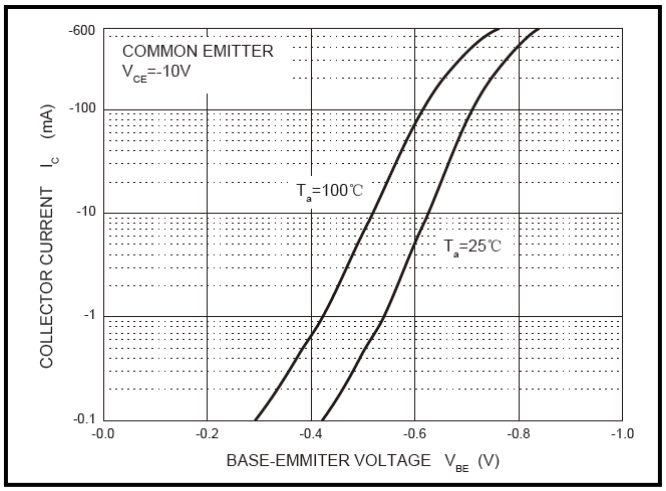
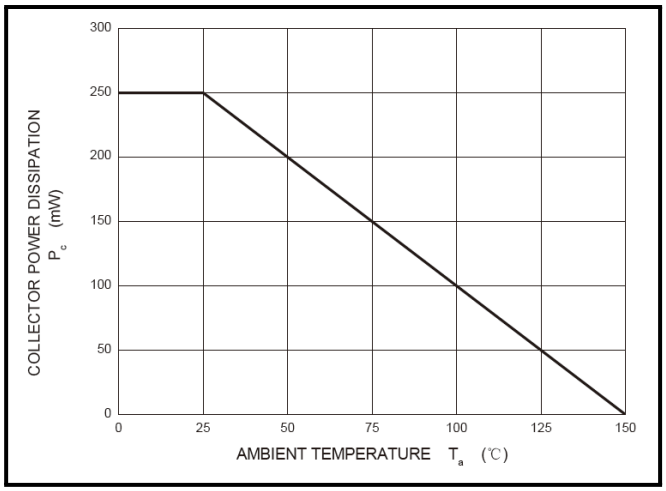


Figure 6 : P_C——T_a

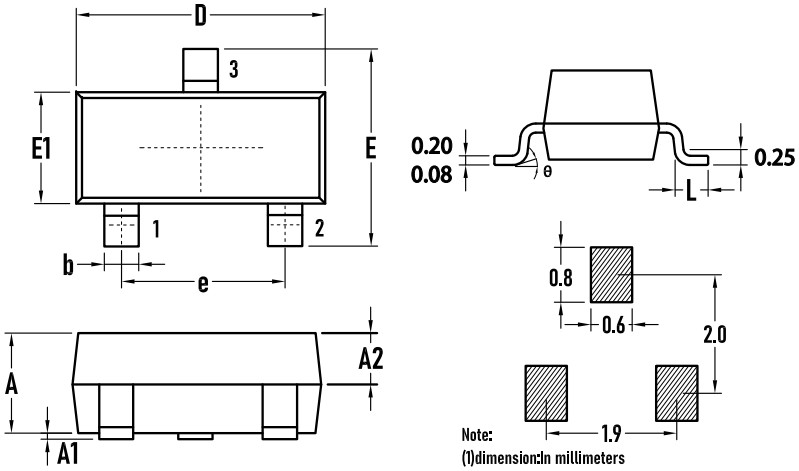


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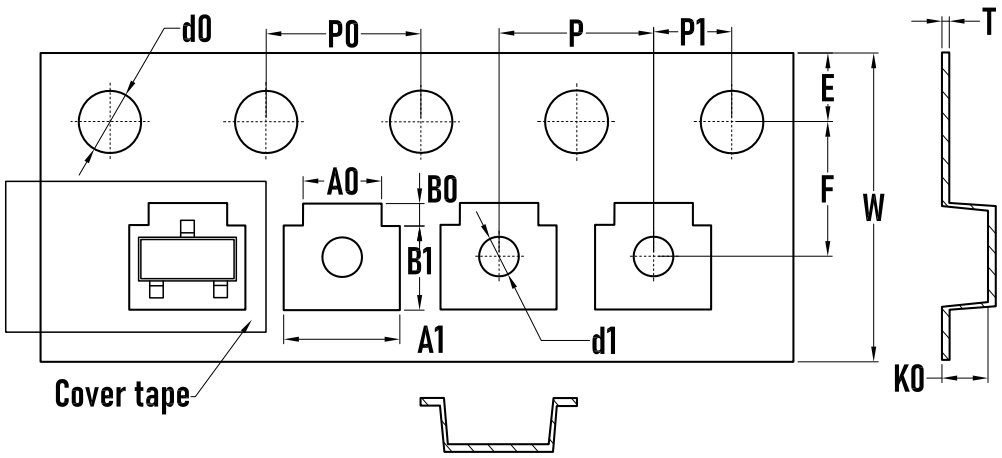
PNP Plastic-Encapsulate Transistor

Outline Drawing - SOT-23



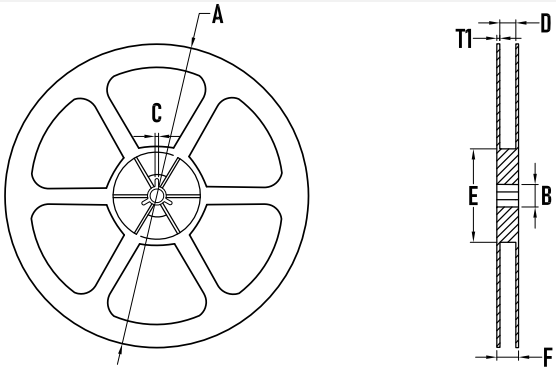
SYMBOL	MILLIMETER		
	MIN.	Typ	MAX
A	0.90	1.00	1.10
A1	0.01	–	0.10
A2	0.50	0.60	0.70
D	2.80	2.90	3.00
b	0.25	0.35	0.45
E	2.10	2.30	2.50
E1	1.20	1.30	1.40
e	1.80	1.90	2.00
L	0.25	0.35	0.45
θ	0	–	8°

Packaging Tape - SOT-23



SYMBOL	MILLIMETER
A0	2.10±0.10
A1	3.10±0.10
B0	0.65±0.10
B1	2.75±0.10
d0	1.55±0.10
d1	1.00±0.05
E	1.75±0.10
F	3.50±0.10
K0	1.10±0.10
P	4.00±0.10
P0	4.00±0.10
P1	2.00±0.10
W	8.00±0.30
T	0.20 ±0.05

Packaging Reel



SYMBOL	MILLIMETER
A	177.8±0.2
B	3.1
C	13.50
D	9.6±0.3
E	75±0.2
F	12.3±0.3
T1	1.0±0.2
Quantity	3000PCS

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